

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc1349cnw#pbf

(Engineering Calculation)

PDIP

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**TOTAL MASS (g) : 4.29335**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.006193	1000000	1442.46337891		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	1.296750	975000	302036.875		
		Iron (Fe)	7439-89-6	0.031920	24000	7434.75439453		
		Phosphorus (P)	7723-14-0	0.000399	300	92.9344329834		
		Zinc (Zn)	7440-66-6	0.000931	700	216.847000122		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>1.330000</b>	<b>1000000</b>	<b>309781.4375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.043454	1000000	10121.1240234		
		<b>External Plating Total:</b>				<b>0.043454</b>	<b>1000000</b>	<b>10121.1240234</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.010640	1000000	2478.25146484		
<b>Internal Plating Total:</b>				<b>0.010640</b>	<b>1000000</b>	<b>2478.25146484</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001548	750000	360.557647705		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000516	250000	120.18586731		
<b>Die Attach Total:</b>				<b>0.002064</b>	<b>1000000</b>	<b>480.743469238</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.391500	135000	91187.5390625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	2.494000	860000	580898.375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.014500	5000	3377.31640625		
		<b>Encapsulation Total:</b>				<b>2.900000</b>	<b>1000000</b>	<b>675463.25</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000999	1000000	232.685455322		
					<b>TOTAL MASS (g) :</b>	<b>4.29335</b>		